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ON Semiconductor®

November 2016

FFSP08120A

Silicon Carbide Schottky Diode 1200 V, 8 A

Features

- · Max Junction Temperature 175 °C
- · Avalanche Rated 80 mJ
- · High Surge Current Capacity
- · Positive Temperature Coefficient
- · Ease of Paralleling
- · No Reverse Recovery / No Forward Recovery

Applications

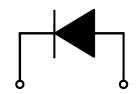
- · General Purpose
- · SMPS, Solar Inverter, UPS
- · Power Switching Circuits

Description

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size & cost.



1. Cathode 2. Anode



1. Cathode 2. Anode

Absolute Maximum Ratings T_C = 25 °C unless otherwise noted.

| Symbol | Paramete | FFSP08120A | Unit | |
|------------------------------------|--|--|-------------|----|
| V_{RRM} | Peak Repetitive Reverse Voltage | | 1200 | V |
| E _{AS} | Single Pulse Avalanche Energy (Note 1) | | 80 | mJ |
| l _F | Continuous Rectified Forward Current @ Tc < 148 °C | | 8 | Α |
| I _{F, Max} | Non-Repetitive Peak Forward Surge Current | T _C = 25 °C, 10 μs | 530 | Α |
| | | T _C = 150 °C, 10 μs | 480 | Α |
| I _{F,SM} | Non-Repetitive Forward Surge Current | Half-Sine Pulse, t _p = 8.3 ms | 68 | Α |
| I _{F,RM} | Repetitive Forward Surge Current | Half-Sine Pulse, t _p = 8.3 ms | 32 | Α |
| Ptot | Power Dissipation | T _C = 25 °C | 166 | W |
| | | T _C = 150 °C | 27 | W |
| T _{.I} , T _{STG} | Operating and Storage Temperature Range | | -55 to +175 | °C |

Thermal Characteristic

| Symbol | Parameter | FFSP08120A | Unit |
|----------------|---|------------|------|
| $R_{	heta JC}$ | Thermal Resistance, Junction to Case, Max | 0.9 | °C/W |

Package Marking and Ordering Information

| Part Number | Top Mark | Package | Packing Method | Reel Size | Tape Width | Quantity |
|-------------|------------|-----------|----------------|-----------|------------|----------|
| FFSP08120A | FFSP08120A | TO-220-2L | Tube | N/A | N/A | 50 units |

Electrical Characteristics $T_C = 25$ °C unless otherwise noted.

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|----------------|-------------------------|---|------|------|------|------|
| | | I _F = 8 A, T _C = 25 °C | - | 1.45 | 1.75 | |
| V _F | Forward Voltage | I _F = 8 A, T _C = 125 °C | - | 1.7 | 2 | V |
| | | I _F = 8 A, T _C = 175 °C | - | 2 | 2.4 | |
| I _R | Reverse Current | $V_R = 1200 \text{ V}, T_C = 25 ^{\circ}\text{C}$ | - | - | 200 | μА |
| | | $V_R = 1200 \text{ V}, T_C = 125 ^{\circ}\text{C}$ | - | - | 300 | |
| | | $V_R = 1200 \text{ V}, T_C = 175 ^{\circ}\text{C}$ | - | - | 400 | |
| Q_C | Total Capacitive Charge | V = 800 V | - | 55 | - | nC |
| С | Total Capacitance | V _R = 1 V, f = 100 kHz | - | 538 | - | pF |
| | | $V_R = 400 \text{ V}, f = 100 \text{ kHz}$ | - | 50 | - | |
| | | $V_R = 800 \text{ V}, f = 100 \text{ kHz}$ | - | 40 | - | |

Notes:

Typical Characteristics $T_J = 25$ °C unless otherwise noted.

Figure 1. Forward Characteristics

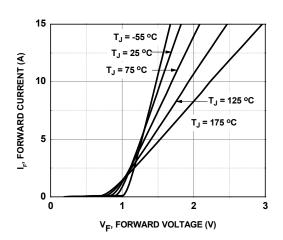


Figure 3. Reverse Characteristics

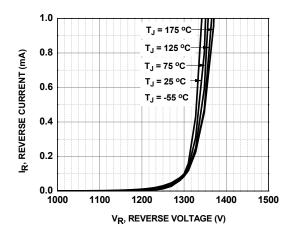


Figure 2. Reverse Characteristics

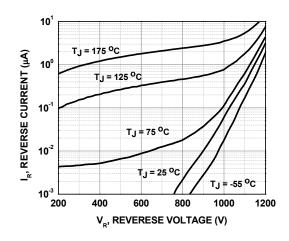
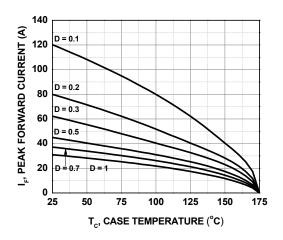


Figure 4. Current Derating



^{1:} EAS of 80 mJ is based on starting T_J = 25 °C, L = 0.5 mH, I_{AS} = 18 A, V = 150 V.

Typical Characteristics T_J = 25 °C unless otherwise noted.

Figure 5. Power Derating

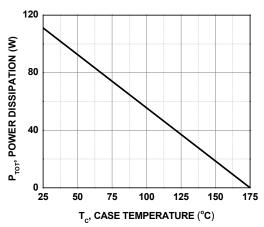


Figure 7. Capacitance vs. Reverse Voltage

Figure 6. Capacitive Charge vs. Reverse Voltage

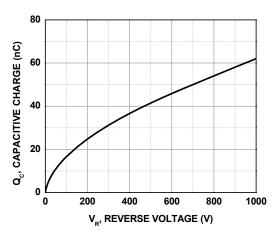
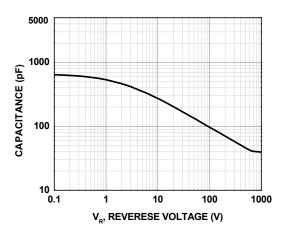


Figure 8. Capacitance Stored Energy



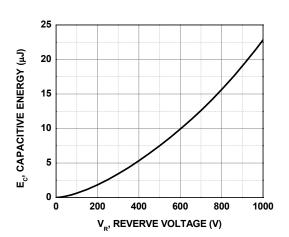
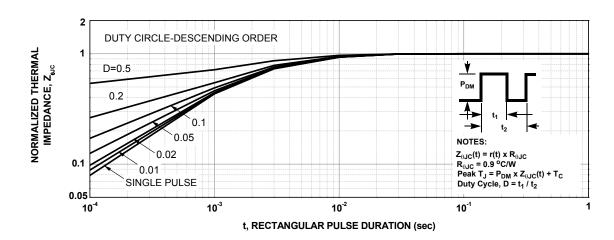
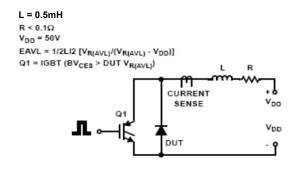


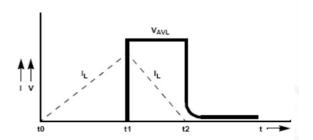
Figure 9. Junction-to-Case Transient Thermal Response Curve

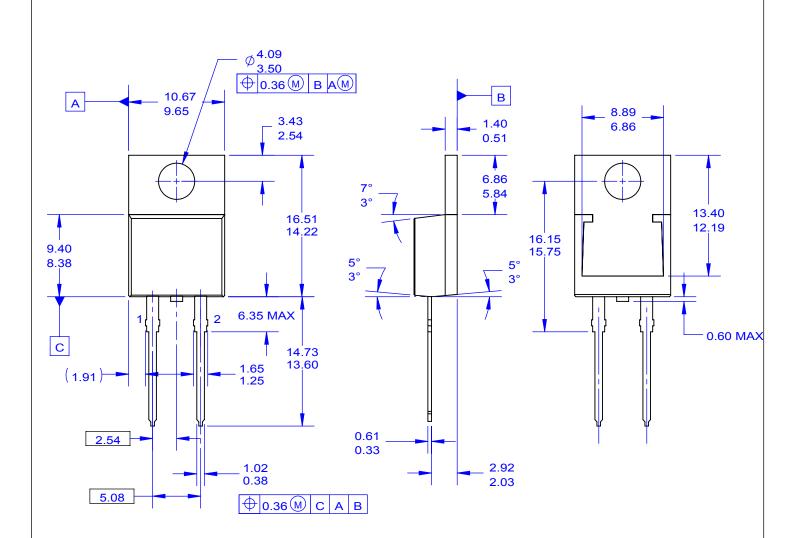


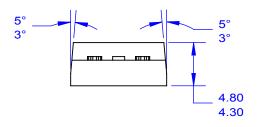
Test Circuit and Waveforms

Figure 10. Unclamped Inductive Switching Test Circuit & Waveform











NOTES:

- A. PACKAGE REFERENCE: JEDEC TO220,ISSUE K, VARIATION AC,DATED APRIL 2002.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
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- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
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